Amendments to the Specification:

Please replace paragraph [0018] at page 3, line 21 with the following amended paragraph.

--[0018] FIGS. 6A-9C show exemplary electrical schematic drawings for electronics that can be used in embodiments of the invention.--

Please replace paragraph [0026] at page 4, line 31 of the specification with the following amended paragraph:

--[0026] A plurality of electrical elements (not shown) may be under the surface. In some embodiments, each electrical element is a pressure-sensitive switch that is activated by pressure. A suitable pressure-sensitive switch may comprise, for example, facing conductive regions that are separated by an air gap. Pressure applied to the conductive regions causes the facing conductive regions to contact each other closing the switch. Another type of electrical element may be a piezoelectric type element. The application of pressure to a Pressure can be applied to the piezoelectric type element eauses it to change resistance. Pressure can be applied by, for example, a finger or a marking instrument such as a crayon that is above the electrical element. Some preferred pressure switches can be MylarTM type switches that are disclosed in U.S. Patent No. 6,608,618, which is herein incorporated by reference in its entirety.--

Please replace paragraph [0045] at page 10, line 13 of the specification with the following amended paragraph:

-[0045] FIG. 6-9 FIGS. 6A-9C show exemplary circuit diagrams of a circuit implementation that can be used in embodiments of the invention. It is understood that many other circuit implementations can be used and yet still arrive at embodiments of the invention.

Please replace paragraph [0046] at page 10, line 16 of the specification with the following amended paragraph:

Appl. No. 10/781,554 Preliminary Amendment

-[0046] FIG. 6 FIGS. 6A-6F shows show a microprocessor 92 which is electrically coupled to the switch array, and the on/off and volume switches shown in FIGS. 7A-7E FIG. 7. The microprocessor 92 may include or be coupled to a memory device that contains code for audio outputs, code or visual outputs, code for an operating system, etc. Many commercially available microprocessors including those commercially available from SunPlus Technologies may be used. The switch array could be under the surface of the platform upon which the book rests. FIG. 8 shows the electrical connections between a membrane PCB (printed circuit board) with the switch array and a main PCB. The main PC is coupled to a speaker and a battery. The speaker is electrically coupled to the microprocessor 92 shown in FIGS. 6A-6F FIG. 6. FIGS. 9A-C show FIG. 9 shows pads for a memory module and a PCB edge connector.--